

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent Application Serial No. 09/488,973
Filing Date January 20, 2000
Inventor C. Parfeniuk et al.
Assignee Honeywell International Inc.
Group Art Unit 2823
Examiner D. Collins
Attorney Docket No. 30-5016(4015) (HO57-002)
Title: Methods of Bonding Physical Vapor Deposition Target Materials to Backing
Plate Materials

Unit 2823
Assistant Commissioner for Patents
Washington, D.C. 20231

FAX RECEIVED

FEB 17 2003

TECHNOLOGY CENTER 2800

CERTIFICATE OF FACSIMILE TRANSMISSION UNDER 37 CFR 1.8

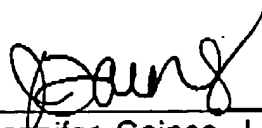
I hereby certify that the following papers are being facsimile transmitted to the Patent and Trademark Office at (703) 872-9318 on the date shown below:

1. Supplemental Response to April 2, 2002 Office Action
2. Version with Markings to Show Changes Made

FEE DEFICIENCY

Although it is believed that no fees are due, the Commissioner is hereby authorized to charge any fees under 37 C.F.R. 1.16 and 1.17 which may be required by this paper to Deposit Account No. 23-0925.

Dated: 2/17/2003

By: 
Jennifer Gaines, Legal Assistant
Telephone No. (509) 624-4276

NUMBER OF PAGES IN FACSIMILE: 6

Appl. No. 09/488,973

#22/ ^{supple}
Amor
D
2/25/03
Vshort

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No.09/488,973
Filing Date January 20, 2000
Inventor Chris Parfeniuk et al.
Assignee Honeywell International Inc.
Group Art Unit 2823
Examiner D. Collins
Attorney's Docket No. 30-5016-(4015)
Title: Methods of Bonding Physical Vapor Deposition Target Materials to Backing Plate
Materials

supplemental RESPONSE TO APRIL 2, 2002 OFFICE ACTION

To: BOX NON FEE AMENDMENT
Assistant Commissioner for Patents
Washington, D.C. 20231

From: David G. Latwesen (Tel. 509-624-4276; Fax 509-838-3424)
Wells, St. John, Roberts, Gregory & Matkin P.S.
601 W. First Avenue, Suite 1300
Spokane, WA 99201-3828

FAX RECEIVED

FEB 17 2003

TECHNOLOGY CENTER 2800

AMENDMENTSIn the Specification

Replace the paragraph beginning on line 21 of page 9 with the following text,

D' -- An exemplary thermal treatment procedure for treating a target and backing plate which comprise aluminum is as follows. Initially, an assembly comprising a target joined against a backing plate is heated to a temperature of from about 280°C to about 400°C (preferably from about 300°C to about 350°C, and more preferably from about 300°C to